# **VEMD8080**

**Vishay Semiconductors** 





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### DESCRIPTION

VEMD8080 is a high speed and high sensitive PIN photodiode with enhanced sensitivity for visible light. It is a low profile surface-mount device (SMD) including the chip with a 4.5 mm<sup>2</sup> sensitive area detecting visible and near infrared radiation.

### FEATURES

- Package type: surface-mount
- Package form: top view
- Dimensions (L x W x H in mm): 4.8 x 2.5 x 0.48
- Radiant sensitive area (in mm<sup>2</sup>): 4.5
- 0.48 mm low profile package
- · Enhanced sensitivity for visible light
- Suitable for visible and near infrared radiation
- · Fast response times
- Angle of half sensitivity:  $\phi = \pm 65^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- High speed photo detector
- Wearables

## PRODUCT SUMMARY

COMPONENT	I <sub>ra</sub> (μΑ) φ (deg)		λ <sub>0.1</sub> (nm)		
VEMD8080	28	± 65	350 to 1100		

### Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VEMD8080	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	Top view		

#### Note

• MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V <sub>R</sub>	20	V
Junction temperature		Тj	85	°C
Operating temperature range		T <sub>amb</sub>	-40 to +85	°C
Storage temperature range		T <sub>stg</sub>	-40 to +85	°C
Soldering temperature	According to reflow solder profile Fig. 8	T <sub>sd</sub>	260	°C
Thermal resistance junction-to-ambient		R <sub>thJA</sub>	350	K/W
ESD safety HBM	± 2000 V, 1.5 kΩ, 100 pF, 3 pulses	ESD <sub>HBM</sub>	≥2	kV



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<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 50 mA	V <sub>F</sub>	-	1.2	1.6	V
Breakdown voltage	I <sub>R</sub> = 100 μA, E = 0	V <sub>(BR)</sub>	20	-	-	V
Reverse dark current	V <sub>R</sub> = 10 V, E = 0	I <sub>ro</sub>	-	0.2	10	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	47	-	pF
	$V_{R} = 3 V, f = 1 MHz, E = 0$	CD	-	17	40	pF
Open circuit voltage	$E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$	Vo	-	320	-	mV
Temperature coefficient of $V_o$	$E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$	TK <sub>Vo</sub>	-	-3.0	-	mV/K
Short circuit current	$E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$	l <sub>k</sub>	-	32	-	μA
Temperature coefficient of ${\sf I}_{\sf k}$	$E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$	TK <sub>lk</sub>	-	0.1	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$ , $\lambda = 850 \text{ nm}$ , $V_R = 5 \text{ V}$	I <sub>ra</sub>	23	28	33	μA
	$E_e = 0.25 \text{ mW/cm}^2$ , $\lambda = 525 \text{ nm}$ , $V_R = 5 \text{ V}$	I <sub>ra</sub>	3.4	4.4	5.3	μA
Angle of half sensitivity		φ	-	± 65	-	deg
Wavelength of peak sensitivity		λ <sub>p</sub>	-	850	-	nm
Range of spectral bandwidth		λ <sub>0.1</sub>	-	350 to 1100	-	nm
Rise time	$V_R = 10 \text{ V}, \text{ R}_L = 1 \text{ k}\Omega, \lambda = 830 \text{ nm}$	t <sub>r</sub>	-	70	-	ns
Fall time	$V_R = 10 \text{ V}, \text{ R}_L = 1 \text{ k}\Omega, \lambda = 830 \text{ nm}$	t <sub>f</sub>	-	70	-	ns

## **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

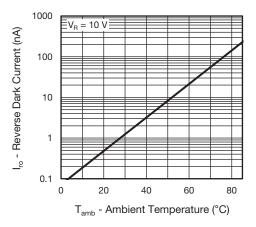


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

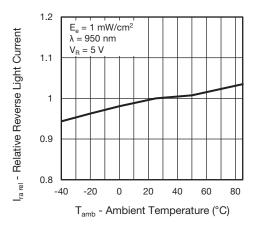
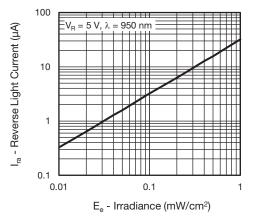


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

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Fig. 3 - Reverse Light Current vs. Irradiance

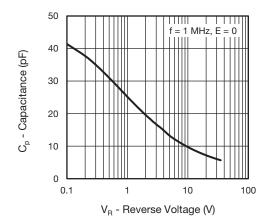


Fig. 4 - Diode Capacitance vs. Reverse Voltage

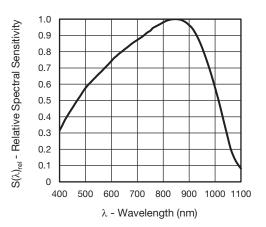


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

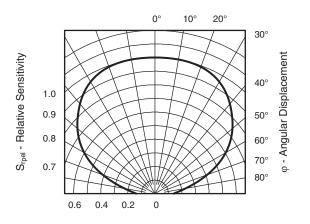


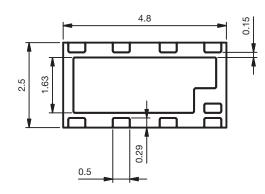
Fig. 6 - Relative Sensitivity vs. Angular Displacement

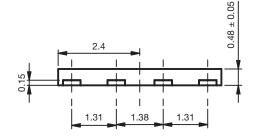
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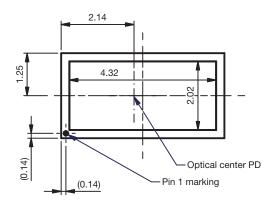




## **PACKAGE DIMENSIONS** in millimeters

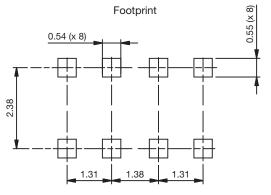






Drawing number: 6.550-5354.01-4 Issue: 1; 20.04.2018

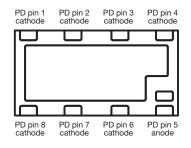
Technical drawings according to DIN specification.



Not indicated tolerances  $\pm$  0.1 mm

Pinning top view				
PD pin 8 cathode	PD pin 7 cathode	PD pin 6 cathode	PD pin 5 anode	
PD pin 1 cathode	PD pin 2 cathode	PD pin 3 cathode	PD pin 4 cathode	

### Pinning bottom view



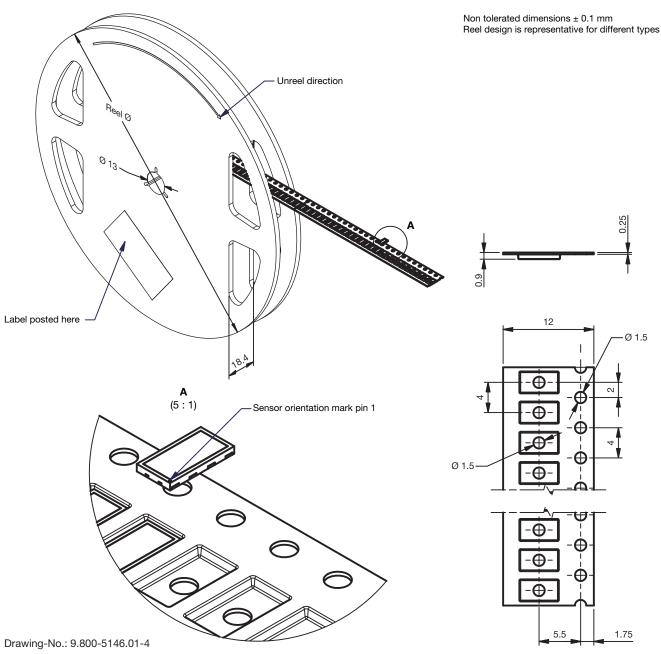
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**VEMD8080** 



### TAPE AND REEL DIMENSIONS in millimeters

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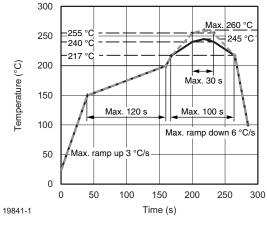


Issue: 1; 20.04.2018

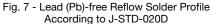
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## SOLDER PROFILE



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### DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

## FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions:  $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$ 

### DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %



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